

High-Side Current Monitor 8V to 450V Voltage Gain of 5

Features

- 8V to 450V Supply Voltage
- Voltage Output Device
- $5 \pm 1\%$ Typical Gain
- 500 mV Maximum V_{SENSE}
- 700 ns to 2 μ s Fast Rise and Fall Time
- 50 μ A Maximum Quiescent Current
- 5-Lead SOT-23 Package

Applications

- Switch Mode Power Supply Current Monitor
- Battery Current Monitor
- Motor Controls
- Telecommunications

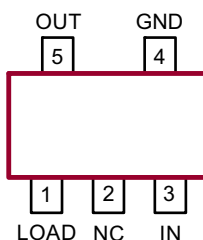
General Description

The HV7801 high-side current monitor IC transfers a high-side current measurement voltage to its ground-referenced output with an accurate voltage gain of five. The measurement voltage typically originates at a current sense resistor which is located in a “high-side” circuit, such as the positive supply line.

This monitor IC features a very wide input voltage range, high accuracy of transfer ratio, small size, low component count, low-power consumption, ease of use, and low cost. Offline, battery and portable applications can be served equally well due to HV7801's wide input voltage range and the low quiescent current.

Package Type

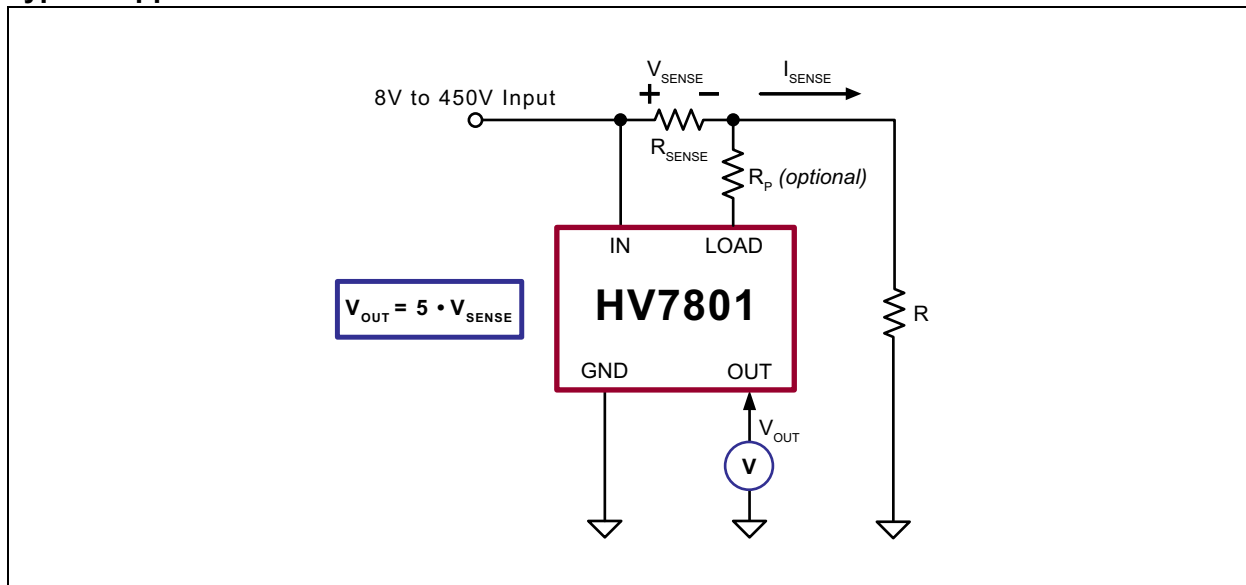
5-lead SOT-23
(Top View)



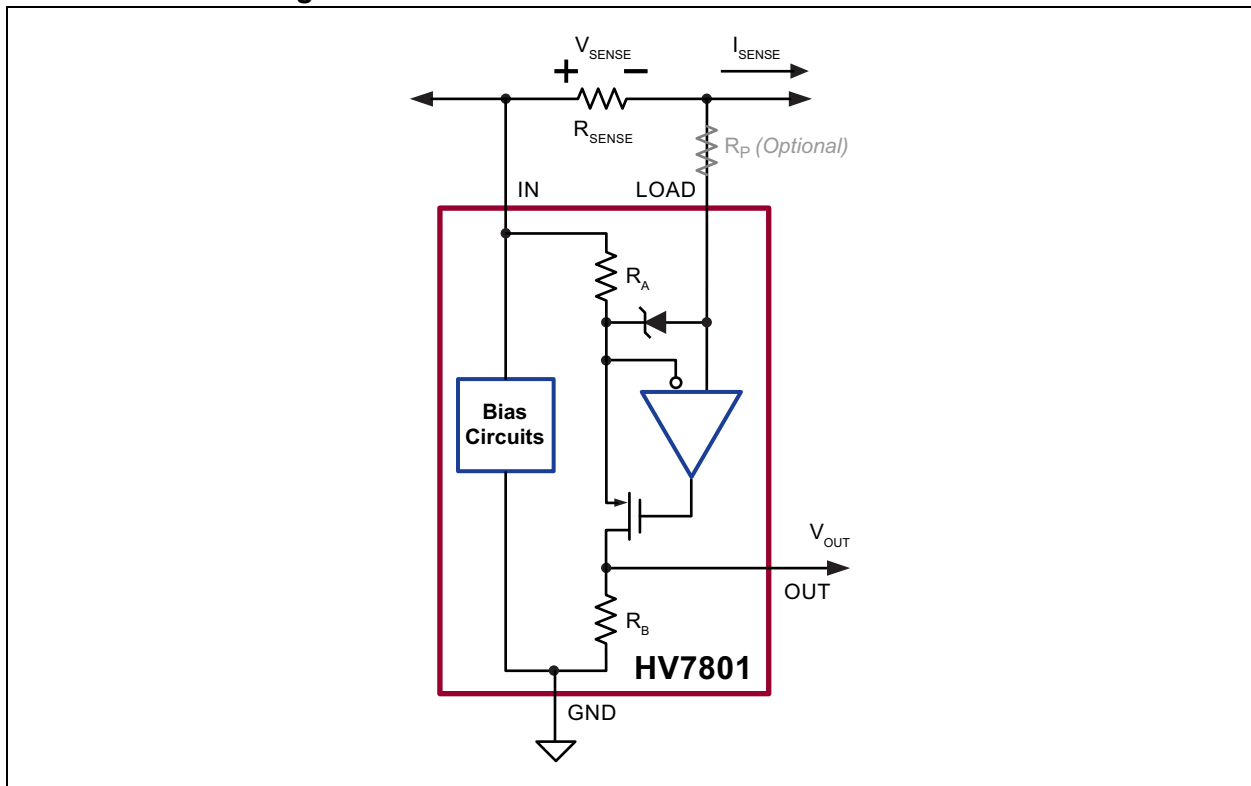
See [Table 2-1](#) for pin information.

HV7801

Typical Application Circuit



Functional Block Diagram



HV7801

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Supply Voltage, V_{IN} , V_{LOAD} (Note 1)	–0.5V to +460V
Output Voltage, V_{OUT} (Note 1)	–0.5V to +10V
Sense Voltage, V_{SENSE} (Note 2)	–0.5V to +5V
Load Current, I_{LOAD} (Note 2)	±10 mA
Operating Ambient Temperature, T_A	–40°C to +85°C
Operating Junction Temperature, T_J	–40°C to +125°C
Storage Temperature, T_S	–65°C to +150°C

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: Referenced to GND

2: $V_{SENSE} = V_{IN} - V_{LOAD}$

ELECTRICAL CHARACTERISTICS

Electrical Specifications: T _A = 25°C unless otherwise noted; V _{IN} = 8V to 450V						
Parameter	Sym.	Min.	Typ.	Max	Unit	Conditions
SUPPLY						
Supply Voltage	V _{IN}	8	—	450	V	Note 1
Quiescent Supply Current	I _Q	—	—	50	μA	V _{IN} = 8V to 450V, V _{SENSE} = 0 mV
INPUT AND OUTPUT						
OUT Pin Output Resistance	R _{OUT}	—	16.5	—	kΩ	
Output Voltage	V _{OUT}	0	—	65	mV	V _{SENSE} = 0 mV
		420	—	580		V _{SENSE} = 100 mV
		913	—	1087		V _{SENSE} = 200 mV
		2395	—	2605		V _{SENSE} = 500 mV
DYNAMIC CHARACTERISTICS						
Output Rise Time, 10% to 90%	t _{RISE}	—	0.7	—	μs	V _{SENSE} = Step 5 mV to 500 mV
		—	—	2		V _{SENSE} = Step 0 mV to 500 mV
Output Fall Time, 90% to 10%	t _{FALL}	—	0.7	2	μs	V _{SENSE} = Step 500 mV to 0 mV (Note 1)

Note 1: Values apply over the full temperature range.

TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Ambient Temperature	T_A	–40	—	+85	°C	
Operating Junction Temperature	T_J	–40	—	+125	°C	
Storage Temperature	T_S	–65	—	+150	°C	
PACKAGE THERMAL RESISTANCE						
5-lead SOT-23	θ_{JA}	—	253	—	°C/W	

2.0 PIN DESCRIPTION

The details on the pins of HV7801 are listed in [Table 2-1](#). Refer to [Package Type](#) for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	LOAD	Sense amplifier input. High-impedance input with Zener diode protection. Add an external protection resistor in series with LOAD if V_{SENSE} exceeds the range of -600 mV to $+5\text{V}$.
2	NC	No Connect. This pin must be left floating for proper operation.
3	IN	Sense amplifier input and supply
4	GND	Supply return
5	OUT	Output with a nominal output resistance of $16.5\text{ k}\Omega$. Preservation of accuracy may require an external buffer amplifier to prevent excessive loading.

3.0 APPLICATION INFORMATION

3.1 General

The HV7801 high-side current monitor IC features accurate current sensing, small size, low component count, low power consumption, exceptional input voltage range, ease of use, and low cost.

The part typically performs the measurement of line or load current for overcurrent protection, metering and current regulation.

High-side current sensing, as opposed to ground-referenced or low-side current sensing, is desirable or required when:

- The current to be measured does not flow in a circuit associated with ground.
- The measurement at ground level can lead to ambiguity due to changes in the grounding arrangement during field use.
- Introduction of a sense resistor in the system ground is undesirable due to issues with safety, electromagnetic interference, or signal degradation caused by common impedance coupling.

3.2 Principle of Operation

The operational amplifier and MOSFET force the voltage across R_A to track V_{SENSE} within the limit of the offset voltage of the opamp, i.e. $V_{RA} = V_{SENSE}$.

The current through R_A returns to ground through R_B . R_A and R_B are integrated, exhibiting tight matching and excellent tracking. By design, R_B is five times larger than R_A . Consequently, V_{RB} is five times larger than V_{RA} , thus resulting in a voltage gain of 5.

3.3 OUT Pin Loading Effects

Note that the OUT pin has a typical output resistance of 16.5 k Ω . Loading the output causes the voltage gain to drop and the rise/fall time to increase.

For example, if given an output resistance of 16.5 k Ω , the load resistance should exceed 16.5 M Ω to limit the drop in gain to 1 part in 1000.

Again assuming output resistance is 16.5 k Ω , capacitive loading of 6 pF results in a response pole with a time constant of 100 ns, which is not high enough to materially affect the output rise and fall time of about 700 ns.

3.4 Sense Resistor Considerations

Limit the sense resistor voltage to 500 mV during normal operating conditions. Limit the power dissipation in the sense resistor to suit the application. A high-sense voltage benefits accuracy but increases power dissipation.

Consider the use of Kelvin connections for applications where significant voltage drops may occur in the PCB traces that carry the current to be measured to the sense resistor. A layout pattern that minimizes voltage across the sense lines is shown in Figure 3-1.

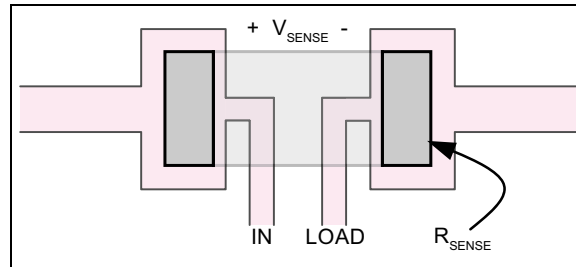


FIGURE 3-1: Kelvin Connection for the Sense Resistor.

Choose a low-inductance type of sense resistor if preservation of bandwidth is important. The use of Kelvin connections helps by excluding the inductive voltage drop across the traces leading to the sense resistor. The inductive voltage drop may be substantial when operating at high frequencies.

A trace or component inductance of just 10 nH contributes an impedance of 6.2 m Ω at 100 kHz, which constitutes a 6% error when using a 100 m Ω sense resistor.

3.5 Transient Protection

Add a protection resistor (R_P) in series with the LOAD pin if V_{SENSE} can exceed 5V in a positive sense or 600 mV in a negative sense, whether in a Steady state or in transient conditions.

A large V_{SENSE} may occur during system startup or shutdown due to the charging and discharging of bulk storage capacitors. V_{SENSE} may be large due to Fault conditions, such as a Short Circuit condition, or a broken or missing sense resistor.

An internal 5V Zener diode with a current rating of 10 mA protects the sense amplifier inputs. The block diagram shows the orientation of this diode. The Zener diode provides clamping at 5V for a positive V_{SENSE} and at 600 mV for a negative V_{SENSE} .

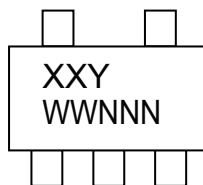
Under worst-case conditions, limit the Zener current to 10 mA. A 100 k Ω resistor limits the Zener diode current to 4.5 mA when V_{SENSE} is 450V, whether positive or negative. Note that the protection resistor may affect the bandwidth. The resistor forms an RC network with the trace and pin capacitance at the LOAD pin. A capacitance of 5 pF results in a time constant of 500 ns.

The protection resistor may cause an offset due to bias current at the LOAD input. Under worst-case bias current (1 nA), a 100 k Ω protection resistor could cause an offset of 100 μ V or 0.2% of full scale. Note that the bias current is nominally zero as the LOAD is a high-impedance CMOS input.

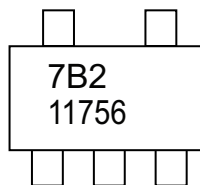
4.0 PACKAGE MARKING INFORMATION

4.1 Packaging Information

5-lead SOT-23



Example

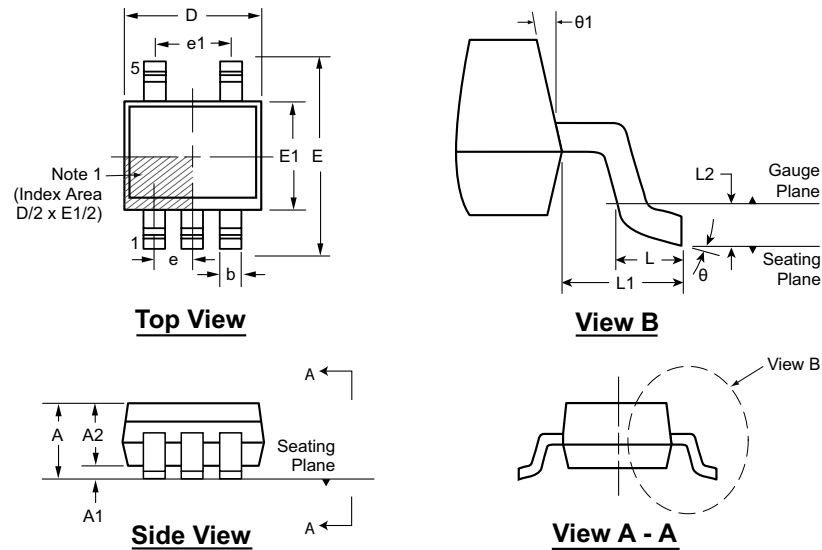


Legend:	XX...X	Product Code or Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

5-Lead SOT-23 Package Outline (K1)

2.90x1.60mm body, 1.45mm height (max), 0.95mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol		A	A1	A2	b	D	E	E1	e	e1	L	L1	L2	θ	θ1
Dimension (mm)	MIN	0.90*	0.00	0.90	0.30	2.75*	2.60*	1.45*	0.95 BSC	1.90 BSC	0.30	0.60 REF	0.25 BSC	0°	5°
	NOM	-	-	1.15	-	2.90	2.80	1.60			0.45			4°	10°
	MAX	1.45	0.15	1.30	0.50	3.05*	3.00*	1.75*			0.60			8°	15°

JEDEC Registration MO-178, Variation AA, Issue C, Feb. 2000.

* This dimension is not specified in the JEDEC drawing.

Drawings not to scale.

APPENDIX A: REVISION HISTORY

Revision A (October 2022)

- Converted Supertex Doc# DSFP-HV7801 to Microchip DS20005632A
- Changed the quantity of the K1 package from 2500/Reel to 3000/Reel to align packaging specifications with the actual BQM
- Made minor text changes throughout the document

HV7801

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To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

<u>PART NO.</u>	<u>XX</u>	-	<u>X</u>	-	<u>X</u>
Device	Package Options		Environmental		Media Type
Device:	HV7801	=	High-Side Current Monitor 8V to 450V Voltage Gain of 5		
Package:	K1	=	5-lead SOT-23		
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		
Media Type:	(blank)	=	3000/Reel for a K1 Package		

Example:

a) HV7801K1-G: High-Side Current Monitor 8V to 450V
Voltage Gain of 5, 5-lead SOT-23,
3000/Reel

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